

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT7557510

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SAMSUNG ELECTRONICS CO., LTD.	09/26/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SEOUL NATIONAL UNIVERSITY R&DB FOUNDATION
<b>Street Address:</b>	SAN 56-1, SILLIM-DONG
<b>Internal Address:</b>	GWANAK-GU, 151-742
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	9536316
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)403-3587
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	202-293-0804
<b>Email:</b>	usdocketing@jeffersonip.com
<b>Correspondent Name:</b>	JEFFERSON IP LAW, LLP
<b>Address Line 1:</b>	1130 CONNECTICUT AVE., NW, SUITE 420
<b>Address Line 4:</b>	WASHINGTON, D.C. 20036
<b>ATTORNEY DOCKET NUMBER:</b>	0502-0672
<b>NAME OF SUBMITTER:</b>	MAENG-HO SHIN
<b>SIGNATURE:</b>	/Maeng-Ho SHIN/
<b>DATE SIGNED:</b>	09/26/2022
<b>Total Attachments: 2</b>	
source=0502-0672 Assignment As Filed#page1.tif	
source=0502-0672 Assignment As Filed#page2.tif	

# RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**

1) Samsung Electronics Co., Ltd.

Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**

Name: Seoul National University R&DB Foundation

Internal Address: \_\_\_\_\_

Street Address: San 56-1, Sillim-dong

Gwanak-gu, 151-742

City: Seoul

State: \_\_\_\_\_

Country: Republic of Korea

Zip: \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No

**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) September 26, 2022

Assignment

Merger

Security Agreement

Change of Name

Joint Research Agreement

Government Interest Assignment

Executive Order 9424, Confirmatory License

Other \_\_\_\_\_

**4. Application or patent number(s):**

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

9,536,316

Additional numbers attached?  Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**

Name: Jefferson IP Law, LLP

Internal Address: Maeng-Ho Shin

Street Address: 1130 Connecticut Ave., NW, Suite 420

City: Washington

State: District of Columbia Zip: 20036

Phone Number: 202-293-0804

Fax Number: 202-403-3587

Email Address: usdocketing@jeffersonip.com

**6. Total number of applications and patents involved:** One

7. Total fee (37 CFR 1.21(h) & 3.41) \$ \_\_\_\_\_

Authorized to be charged by credit card

Authorized to be charged to deposit account

Enclosed

None required (government interest not affecting title)

**8. Payment Information**

a. Credit Card Last 4 Numbers \_\_\_\_\_  
Expiration Date \_\_\_\_\_

b. Deposit Account Number \_\_\_\_\_

Authorized User Name \_\_\_\_\_

**9. Signature:**

/Maeng-Ho SHIN/ Reg. #53,859

September 26, 2022

Signature

Date

Maeng-Ho Shin

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

2

**PATENT ASSIGNMENT**

**Samsung Electronics Co., Ltd.** having offices at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea and **Seoul National University R&DB Foundation**, having offices at San 56-1, Sillim-dong, Gwanak-gu, Seoul, 151-742, Republic of Korea are the co-owners of the following Patent:

9,536,316

**Samsung Electronics Co., Ltd.** hereby transfers and assigns to **SEOUL NATIONAL UNIVERSITY R&DB FOUNDATION** having a business address at San 56-1, Sillim-dong, Gwanak-gu, Seoul, 151-742, Republic of Korea:

(i) all of right, title and interest in and to the aforementioned U.S. Patent; and

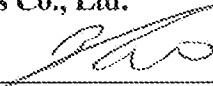
(ii) all rights in and to causes of action and enforcement rights for the Patent Rights including all rights to pursue damages, injunctive relief and other remedies for past, current, and future infringement of the Patent Rights.

The terms and conditions of this Assignment shall inure to the benefit of Assignee, its successors, assigns and other legal representatives, and shall be binding upon Assignor, its successor, assigns and other legal representatives.

**IN WITNESS WHEREOF**, this Assignment is signed by its duly authorized representative.

Agreed and Accepted:

**Samsung Electronics Co., Ltd.**

By: 

Name: Young Hak Kong

Title: Principal Engineer, IP Prosecution Team

Date: September 26, 2022